



Product Change Notification: DSNO-18SQTN760

Date:

03-Sep-2025

Product Category:

Switching Regulators

Notification Subject:

CCB 7580 Initial Notice: Qualification of ATP7 as an additional assembly site for selected MIC2875 and MIC2876 device families available in 8L UDFN (2x2x0.6mm) package.

Affected CPNs:

[DSNO-18SQTN760_Affected_CPN_09032025.pdf](#)

[DSNO-18SQTN760_Affected_CPN_09032025.csv](#)

PCN Status: Initial Notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section.

Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change: Qualification of ATP7 as an additional assembly site for selected MIC2875 and MIC2876 device families available in 8L UDFN (2x2x0.6mm) package.

Pre and Post Summary Changes:

	Pre Change	Post Change	
Assembly Site	Unisem Chengdu Co.,Ltd (UNIC)	Unisem Chengdu Co.,Ltd. (UNIC)	Amkor Technology Philippines (P3/P4), INC. (ATP7)
Wire Material	Cu	Cu	CuPdAu
Die Attach Material	8290	8290	CDF215
Molding Compound Material	G770HP	G770HP	G631BQF

Lead-Frame Material	C194	C194	C7025
Lead-Frame Paddle Size	69x41mils	69x41mils	67x39mils
Lead-Frame Design	See Pre and Post Change Summary attachment for comparison.		
DAP Surface Prep	Spot Ag	Spot Ag	Ring Ag

Impacts to Datasheet: None

Change Impact: None

Reason for Change: To improve on-time delivery performance by qualifying ATP7 as an additional assembly site.

Change Implementation Status: In Progress

Estimated Qualification Completion Date: November 2025

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

Timetable Summary:

	May 2025					>	November 2025				
Work Week	18	19	20	21	22		45	46	47	48	49
Initial PCN Issue Date				X							
Qual Report Availability											X
Final PCN Issue Date											X

Method to Identify Change: Traceability Code

Qualification Plan: Please open the attachments included with this PCN labeled as PCN_#_Qual_Plan.

Revision History: May 21, 2025: Issued initial notification.

September 03, 2025: Re-issued initial notification to update die-attach material from AP4300 to CDF215.

Note: The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable product.

Attachments:

PCN_DSNO-18SQTN760-Qual_Plan.pdf

PCN_DSNO-18SQTN760_Pre and Post Change Summary.pdf

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to receive Microchip PCNs via email please register for our PCN email service at our [PCN home page](#) select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the [PCN FAQ](#) section.

If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

Affected Catalog Part Numbers (CPN)

MIC2876-5.25YMT-T5

MIC2875-5.5YMT-T5

MIC2876-5.5YMT-T5

MIC2876-4.75YMT-T5

MIC2875-5.25YMT-T5

MIC2875-4.75YMT-T5

MIC2876-AYMT-T5

MIC2876-5.5YMT-TR

MIC2876-5.25YMT-TR

MIC2876-5.0YMT-TR

MIC2876-4.75YMT-TR

MIC2875-AYMT-T5

MIC2875-5.5YMT-TR

MIC2875-5.0YMT-TR

MIC2875-5.0YMT-T5

MIC2875-4.75YMT-TR

MIC2876-5.0YMT-T5

MIC2876-AYMT-TR

MIC2875-AYMT-TR

MIC2875-5.25YMT-TR